

	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE		COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
	1	RE-6-2688	S.J.H	L.S.M	2022.05.11						
APPLICABLE STANDARD											
RATING	Operating Temperature Range		-55℃ to 105℃ (Note1)			Storage Temperature Range		-10℃ to 60℃ (Note3)			
	Operating Humidity Range		20% to 80% (Note2)			Storage Humidity Range		40% to 70% (Note3)			
	Current		AWG 32 : 0.8A AWG 30 : 1.0A AWG 28 : 1.0A			Voltage		100V AC/DC			
						Applicable Connector		KW30-10P-1C(###)			
SPECIFICATIONS											
ITEM		TEST METHOD				REQUIREMENTS				QT	AT
CONSTRUCTION											
General Examination		Visually and by measuring instrument.				According to drawing.				0	0
Marking		Confirmed visually.								0	0
ELECTRICAL CHARACTERISTICS											
Contact Resistance		20mV MAX, 10mA (DC or 1000Hz).				30 mΩ MAX.				0	-
Millivolt Level Method											
Insulation Resistance		250 V DC.				100 MΩ MIN.				0	-
Voltage Proof		500 V AC for 1 min.				No flashover or breakdown.				0	-
MECHANICAL CHARACTERISTICS											
Mating and unmating force		It takes out and inserts with a conformity connector				①Insertion Force : 31N MAX ②Extraction Force : 3.7N MIN				0	-
Mechanical Operation (Au Plating)		30 times insertion and extraction.				①Contact resistance : 50mΩ MAX ②No damage, crack or looseness of parts. ③Extraction Force : 3.7N MIN				0	-
Vibration		Frequency 10 to 55 Hz, single amplitude 1.52 mm, at 2 hours for 3 direction.				①No electrical discontinuity of 1 μ s. ②Contact resistance : 50 mΩ MAX.				0	-
Shock		Acceleration 490 m/s ² duration of pulse 11 ms at 3times for 3 directions.				③No damage, crack or looseness of parts.				0	-
ENVIRONMENTAL CHARACTERISTICS											
Damp Heat (Steady State)		Exposed at 40 ± 2 °C , humidity 90 to 95 %, 240 h.				①Contact resistance : 50 mΩ MAX. ②Insulation resistance : 100MΩ MIN. ③No damage, crack or looseness of parts.				0	-
Rapid Change of Temperature		Temperature -55 °C → 105 °C Time 30min → 30min 25 Cycles. (The transferring time of the tank is 2 to 3 MIN) (After leaving the room temperature for 1 to 2h.)				①Contact resistance : 50 mΩ MAX. ②Insulation resistance : 100MΩ MIN. ③After Voltage proof test No flashover or breakdown. ④No damage, crack or looseness of parts.				0	-
Dry Heat		Exposed at 105±2 °C, 250h								0	-
Gold		Exposed at -55±3 °C, 250h								0	-
Corrosion, Salt Mist		Exposed in 35±2 % salt water spray for 48h.				Contact resistance : 50 mΩ MAX.				0	-
Hydrogen Sulfide		Exposed in 40±2 °C, humidity 80±5% 3±1 ppm for 96h.				Contact resistance : 50 mΩ MAX.				0	-
Note 1: Include the temperature rising by current. Note 2: No condensing Note 3: Apply to the condition of long term storage for unused products before PCB on board. After PCB on board, operating temperature and humidity range is applied for interim storage during transportation.											
Remark					DRAWN	DESIGNED	CHECKED	APPROVED	RELEASED		
					S.W.CHOI	S.W.CHOI	S.M.LIM	S.M.LIM			
					20.06.29	20.06.29	20.06.30	20.06.30			
Unless otherwise specified, refer to IEC 60512.											
NOTE QT: QUALIFICATION TEST AT: ASSURANCE TEST O: APPLICABLE TEST											
HIROSE KOREA CO.,LTD.			SPECIFICATION SHEET				PART NO. KW30-10S-1H (800)				
CODE NO.(OLD)		DRAWING NO.			CODE NO.					1/2	
CL		ELC4-633094			CL 6669-0011-7-800						

Resistance To Soldering Heat	Reflow time Number of reflow cycles : 2cycles MAX. Duration above 220°C, 60sec. MAX. Peak temperature : 250°C 10sec. MAX.	No deformation of case of excessive looseness of the terminals.	O	—
Solderability	Soldered at solder temperature 245 °C for in immersion, duration, 5s.	New uniform coating of solder shall cover minimum of 95 % of the surface being immersed.	O	—

NOTE QT: QUALIFICATION TEST AT: ASSURANCE TEST O: APPLICABLE TEST				
HIROSE KOREA CO.,LTD.		SPECIFICATION SHEET		PART NO. KW30-10S-1H (800)
CODE NO.(OLD) CL	DRAWING NO. ELC4-633094	CODE NO. CL 6669-0011-7-800	2/2	